

10-20-1998

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or copy thereof.

1. Name of conveying party(ies)  
Katsuki HAZAMAAddit'l name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement  
☐ Change of name  
☐ Other

Execution Date: September 30, 1998

2. Name and address of receiving party(ies):

Nippon Steel Corporation  
6-3, Otemachi 2-chome, Chiyoda-ku, Tokyo-to, JapanAddit'l. name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s): 09168116

If this document is being filed together with a new application, the execution date of the application is: September 30, 1998

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Pollock, Vande Sande & Amernick  
Suite 800  
1990 M Street, N.W.  
Washington State: D.C. Zip: 20036

6. Total number of applications and patents involved [1]

7. Total fee (37 CFR 3.41).....\$40.00

- ☒ Enclosed  
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9. Statement and signature  
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date:

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PATENT  
 REEL: 9511 FRAME: 0783

## ASSIGNMENT

WHEREAS, I, Katsuki HAZAMA, respectively, have  
invented certain improvements in and to "SEMICONDUCTOR DEVICE WITH LOGIC REWRITING  
AND SECURITY PROTECTION FUNCTION"  
\_\_\_\_\_ " and described in the application for United States Letters Patent therefor,  
executed on even date herewith;

WHEREAS, NIPPON STEEL CORPORATION, of 6-3, Otemachi 2-chome,  
Chiyoda-ku, Tokyo-to, Japan (hereinafter referred to as "ASSIGNEE"),  
is desirous of acquiring the entire right, title and interest in and to said invention and in and to  
any Letters Patent that may be granted therefor in the United States and its territorial possessions,  
and in any and all foreign countries and all reissues, divisions, continuations, extensions,  
substitutions and renewals thereof;

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00), the receipt  
whereof is hereby acknowledged, and for other good and valuable consideration, I, by these  
presents, do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said  
invention in the United States and its territorial possessions, and in all foreign countries and the  
entire right, title and interest in and to any and all Letters Patent which may be granted therefor  
in the United States and its territorial possessions, and in any and all foreign countries, and in and  
to any and all divisions, reissues, continuations, substitutions, renewals and extensions thereof,  
and all rights of priority resulting from the filing of said U.S. application.

I hereby authorize and request the Patent Trademark Office officials in the United States  
and its territorial possessions and any and all foreign countries to issue any and all of said Letters  
Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in  
and to the same, for the sole use and behoof of the said ASSIGNEE, its successors and assigns,

to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

FURTHER, I agree that I will communicate to said ASSIGNEE or its representatives any facts known to respecting said discovery, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and generally do everything possible to aid said ASSIGNEE, its successors, and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions, and in any and all foreign countries.

IN TESTIMONY WHEREOF, I hereunto set my hands as follows:

Date: September 30, 1998

By: *Katsuko Hayama*